

M74HC266P**QUADRUPLE 2-INPUT EXCLUSIVE NOR GATE****DESCRIPTION**

The M74HC266 is a semiconductor integrated circuit consisting of four 2-input exclusive NOR gates.

FEATURES

- High-speed: 9ns typ. ($C_L=15\text{pF}$, $V_{CC}=5\text{V}$)
- Low power dissipation: $5\mu\text{W}/\text{package}$ (max)
($V_{CC}=5\text{V}$, $T_a=25^\circ\text{C}$, quiescent state)
- High noise margin: 30% of V_{CC} , min ($V_{CC}=4.5\text{V}$, 6V)
- Capable of driving 10 LSTTL loads
- Wide operating voltage range: $V_{CC}=2\sim 6\text{V}$
- Wide operating temperature range: $T_a=-40\sim 85^\circ\text{C}$

APPLICATION

General purpose, for use in industrial and consumer digital equipment.

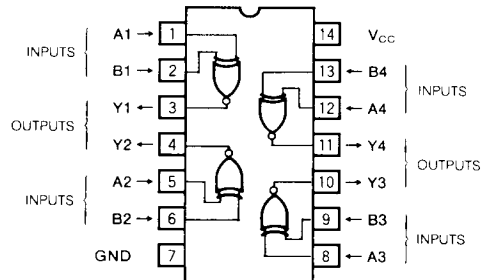
FUNCTIONAL DESCRIPTION

Use of silicon gate technology allows the M74HC266 to maintain the low power dissipation and high noise margin characteristics of the standard CMOS logic 4000B series while giving high-speed performance equivalent to the 74LS266.

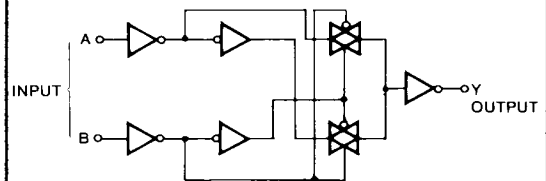
Buffered outputs Y improve input-to-output transfer characteristics and reduce to a minimum output impedance variations with respect to input voltage variations.

When both inputs A and B are either high or low, the output Y will become high, and when the levels of A and B are opposite, the output Y will become low.

Note that the output of M74HC266 and 74LS266 differ in that the output of the M74HC266 is not open drain.

PIN CONFIGURATION (TOP VIEW)

Outline 14P4

LOGIC DIAGRAM (EACH GATE)**FUNCTION TABLE**

Inputs		Output
A	B	Y
L	L	H
H	L	L
L	H	L
H	H	H

ABSOLUTE MAXIMUM RATINGS ($T_a = -40\sim +85^\circ\text{C}$)

Symbol	Parameter	Conditions	Ratings	Unit
V_{CC}	Supply voltage		$-0.5\sim +7.0$	V
V_i	Input voltage		$-0.5\sim V_{CC}+0.5$	V
V_o	Output voltage		$-0.5\sim V_{CC}+0.5$	V
I_{iK}	Input protection diode current	$V_i < 0\text{V}$	-20	mA
		$V_i > V_{CC}$	20	
I_{oK}	Output parasitic diode current	$V_o < 0\text{V}$	-20	mA
		$V_o > V_{CC}$	20	
I_o	Output current, per output pin		± 25	mA
I_{CC}	Supply/GND current	V_{CC} , GND	± 50	mA
P_d	Power dissipation		500	mW
T_{stg}	Storage temperature range		$-65\sim +150$	$^\circ\text{C}$

QUADRUPLE 2-INPUT EXCLUSIVE NOR GATE

RECOMMENDED OPERATING CONDITIONS ($T_a = -40 \sim +85^\circ\text{C}$)

Symbol	Parameter	Limits			Unit
		Min	Typ	Max	
V_{CC}	Supply voltage	2		6	V
V_I	Input voltage	0		V_{CC}	V
V_O	Output voltage	0		V_{CC}	V
T_{opr}	Operating temperature range	-40		+85	$^\circ\text{C}$
t_r, t_f	Input risetime, falltime	$V_{CC} = 2.0\text{V}$	0	1000	ns
		$V_{CC} = 4.5\text{V}$	0	500	
		$V_{CC} = 6.0\text{V}$	0	400	

ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test conditions	Limits						Unit
			25 $^\circ\text{C}$			-40 \sim +85 $^\circ\text{C}$			
			$V_{CC}(\text{V})$	Min	Typ	Max	Min	Max	
V_{IH}	High-level input voltage	$V_O = 0.1\text{V}, V_{CC} = 0.1\text{V}$ $ I_O = 20\mu\text{A}$	2.0	1.5			1.5		V
			4.5	3.15			3.15		
			6.0	4.2			4.2		
V_{IL}	Low-level input voltage	$V_O = 0.1\text{V}, V_{CC} = 0.1\text{V}$ $ I_O = 20\mu\text{A}$	2.0			0.5		0.5	V
			4.5			1.35		1.35	
			6.0			1.8		1.8	
V_{OH}	High-level output voltage	$V_I = V_{IH}, V_{IL}$	$I_{OH} = -20\mu\text{A}$	2.0	1.9			1.9	V
			$I_{OH} = -20\mu\text{A}$	4.5	4.4			4.4	
			$I_{OH} = -20\mu\text{A}$	6.0	5.9			5.9	
			$I_{OH} = -4.0\text{mA}$	4.5	4.18			4.13	
			$I_{OH} = -5.2\text{mA}$	6.0	5.68			5.63	
V_{OL}	Low-level output voltage	$V_I = V_{IH}, V_{IL}$	$I_{OL} = 20\mu\text{A}$	2.0			0.1	0.1	V
			$I_{OL} = 20\mu\text{A}$	4.5			0.1	0.1	
			$I_{OL} = 20\mu\text{A}$	6.0			0.1	0.1	
			$I_{OL} = 4.0\text{mA}$	4.5			0.26	0.33	
			$I_{OL} = 5.2\text{mA}$	6.0			0.26	0.33	
I_{IH}	High-level input current	$V_I = 6\text{V}$	6.0			0.1	1.0	μA	
I_{IL}	Low-level input current	$V_I = 0\text{V}$	6.0			-0.1	-1.0	μA	
I_{CC}	Quiescent supply current	$V_I = V_{CC}, \text{GND}, I_O = 0\mu\text{A}$	6.0			1.0	10.0	μA	

QUADRUPLE 2-INPUT EXCLUSIVE NOR GATE

SWITCHING CHARACTERISTICS ($V_{CC} = 5V, T_a = 25^{\circ}C$)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
t_{TLH}	Low-level to high-level and high-level to low-level output transition time	$C_L = 15pF$ (Note 2)			10	ns
t_{THL}					10	
t_{PLH}	Low-level to high-level and high-level to low-level output propagation time				20	ns
t_{PHL}					20	

SWITCHING CHARACTERISTICS ($V_{CC} = 2\sim 6V, T_a = -40\sim +85^{\circ}C$)

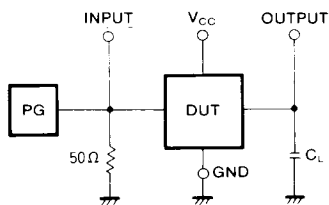
Symbol	Parameter	Test conditions	Limits						Unit
			$V_{CC}(V)$	25°C			-40~+85°C		
				Min	Typ	Max	Min	Max	
t_{TLH}	Low-level to high-level and high-level to low-level output transition time	$C_L = 50pF$ (Note 2)	2.0			75		95	ns
			4.5			15		19	
			6.0			13		16	
t_{THL}	output transition time		2.0			75		95	
			4.5			15		19	
			6.0			13		16	
t_{PLH}	Low-level to high-level and high-level to low-level output propagation time	2.0			120		151	ns	
		4.5			24		30		
		6.0			20		26		
t_{PHL}	output propagation time	2.0			120		151		
		4.5			24		30		
		6.0			20		26		
C_i	Input capacitance						10	pF	
C_{PD}	Power dissipation capacitance (Note 1)				38			pF	

Note 1 : C_{PD} is the internal capacitance of the IC calculated from operation supply current under no-load conditions. (per gate)

The power dissipated during operation under no-load conditions is calculated using the following formula:

$$P_D = C_{PD} \cdot V_{CC}^2 \cdot f_i + I_{CC} \cdot V_{CC}$$

Note 2 : Test Circuit



- (1) The pulse generator (PG) has the following characteristics (10%~90%): $t_r = 6ns, t_f = 6ns$
- (2) The capacitance C_L includes stray wiring capacitance and the probe input capacitance.

TIMING DIAGRAM

